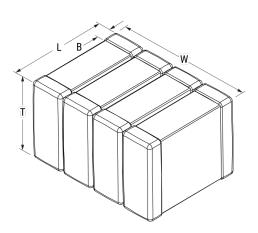


CKC21C483KEGLC7810

KONNEKT KC-LINK Comm COG, Ceramic, 0.048 uF, 10%, 1200 VDC, COG, 4-Chip Low Loss Orientation.



General Information	
Series	KONNEKT KC-LINK Comm COG
Style	KONNEKT
Description	KC-LINK with KONNEKT, SMD, MLCC, Ultra- Stable, Class I
Features	Ultra-Stable
RoHS	Yes
Termination	Tin
AEC-Q200	No
Component Weight	1.4 g
Notes	4-Chip Low Loss Orientation.
Chip Size	2220-4
MSI	1

Dimensions	
L	5.7mm +/-0.4mm
W	10.3mm +/-0.8mm
Т	5mm +/-0.4mm
В	0.6mm +/-0.35mm

Packaging Specifications		
Packaging	T&R, 330mm	
Packaging Quantity	525	

Specifications	
Capacitance	0.048 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	1200 VDC
Dielectric Withstanding Voltage	1440 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	21 MOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

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